

L Number	Hits	Search Text	DB	Time stamp
1	20	"5985043"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/01 14:05
2	7394	((pin adj grid adj array) pga) and (method process)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/01 14:59
3	165700	(polymer polymeric polyimide plastic) with (pad substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/01 15:08
4	1035	((pin adj grid adj array) pga) and (method process)) and ((polymer polymeric polyimide plastic) with (pad substrate))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/01 15:08
5	4608	(solder flux) near3 pin	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/01 15:09
6	154	((pin adj grid adj array) pga) and (method process)) and ((polymer polymeric polyimide plastic) with (pad substrate)) and ((solder flux) near3 pin)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/04/01 15:09